

60V N-Channel Power MOSFET

DESCRIPTION :

- Reliable and Rugged
- Fast switching speed
- 100% UIS Tested, 100%Rg Tested
- Pb-Free Lead Plating
- RoHS compliant

V_{DSS}	60V
I_D	153A
$R_{DS(ON)_{Max}}$	3.9m Ω

TYPICAL APPLICATIONS :

- DC/DC converter



TO-247AB

MAXIMUM RATINGS (at $T_J = 25\text{ }^\circ\text{C}$, unless otherwise specified)

Characteristic	Condition	Symbol	Value	Unit
Drain-Source Voltage		V_{DSS}	60	V
Gate-Source Voltage		V_{GSS}	± 20	V
Pulsed Drain Current ⁽¹⁾	$T_c=25^\circ\text{C}$	I_{DM}	382	A
Continuous Drain Current	$T_c=25^\circ\text{C}$ $T_c=100^\circ\text{C}$	I_D	153 97	A
Single Pulsed Avalanche Energy ⁽²⁾	$L=0.1\text{mH}$ $L=0.5\text{mH}$	E_{AS}	140 210	mJ
Maximum Power dissipation	$T_c=25^\circ\text{C}$ $T_c=100^\circ\text{C}$	P_D	125 50	W
Junction & Storage temperature Range		T_J, T_{STG}	-55~+150	$^\circ\text{C}$

Notes : 1. Max. current is limited by junction temperature

2. UIS tested and pulse width are limited by maximum junction temperature 150 $^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Condition	Symbol	Value	Unit
Thermal resistance,	Junction – Ambient Junction - Case	$R_{\theta(j-A)}$ $R_{\theta(j-C)}$	62.5 1.0	$^\circ\text{C/W}$

ELECTRICAL CHARACTERISTICS (at $T_J = 25\text{ }^\circ\text{C}$, unless otherwise specified)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage VGS = 0V, ID = 250uA	BV _{DSS}	60			V
Zero Gate Voltage Drain Current VDS = 48 V, VGS = 0 V Tj=25°C	I _{DSS}			1	uA
Gate-Source Leakage Current VGS = ±20V, VDS = 0V	I _{GSS}			±100	nA
Gate-Source threshold voltage VDS = VGS, ID = 250uA	V _{GS(th)}	2	3	4	V
Drain-Source On-State Resistance VGS = 10V, ID = 20A	R _{DS(on)}		3.2	3.9	mΩ
Input capacitance f=1MHz, VDS=30 V, VGS=0 V	C _{iss}		5610		pF
Output capacitance f=1MHz, VDS=30 V, VGS=0 V	C _{oss}		1188		pF
Reverse transfer capacitance f=1MHz, VDS=30 V, VGS=0 V	C _{rss}		100		pF
Gate Resistance f=1MHz, VDS=0 V, VGS=0 V	R _g		0.7		Ω
Total Gate Charge VDS= 30V, ID= 20A, VGS= 10V	Q _G		83.5		nC
Gate to Source Charge VDS= 30V, ID= 20A, VGS= 10V	Q _{GS}		29.4		nC
Gate to Drain Charge VDS= 30V, ID= 20A, VGS= 10V	Q _{GD}		13.5		nC
Turn-on delay time VDD=40 V, VGS= 10V, ID= 30A, R _{GEN} =3Ω	td _(ON)		26.4		ns
Turn-on Rise time VDD=40 V, VGS= 10V, ID= 30A, R _{GEN} =3Ω	tr		7.7		ns
Turn-off delay time VDD=40 V, VGS= 10V, ID= 30A, R _{GEN} =3Ω	td _(OFF)		59		ns
Turn-off Fall time VDD=40 V, VGS= 10V, ID= 30A, R _{GEN} =3Ω	tf		91.7		ns

Body Diode

ELECTRICAL CHARACTERISTICS (at $T_J = 25\text{ }^\circ\text{C}$, unless otherwise specified)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Diode Forward Voltage $V_{GS} = 0V, I_S = 10A$	V_{SD}		0.75	1.1	V
Maximum Continuous Body Diode Forward Current	I_S			43	A
Revers Recovery Time $I_F = 10A, V_R = 40V, dI_F/dt = 100A/\mu s$	T_{rr}		52		ns
Revers Recovery Charge $I_F = 10A, V_R = 40V, dI_F/dt = 100A/\mu s$	Q_{rr}		65		nC

Typical Characteristics

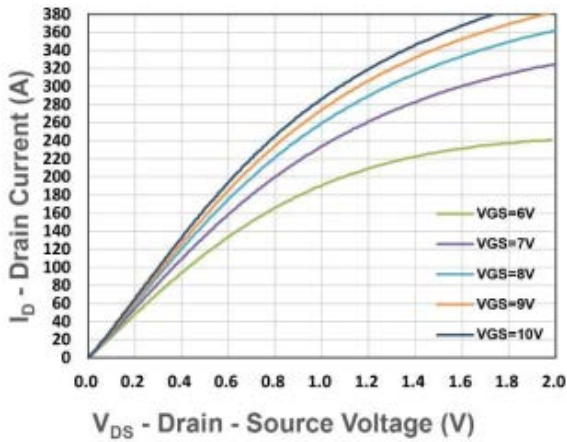


Figure 1. Output Characteristics

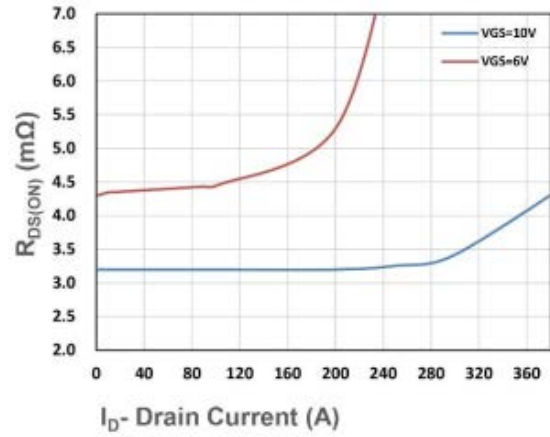


Figure 2. On Resistance vs. ID

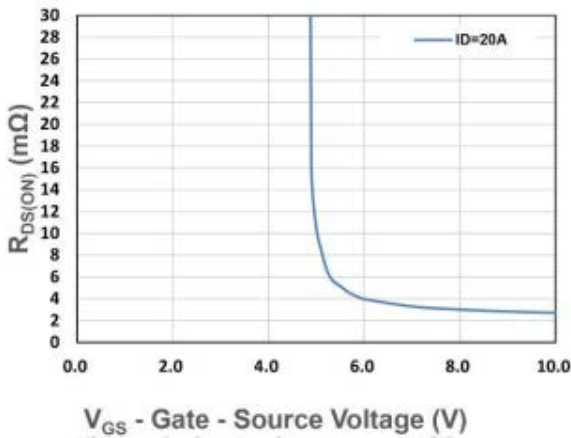


Figure 3. On Resistance vs. VGS

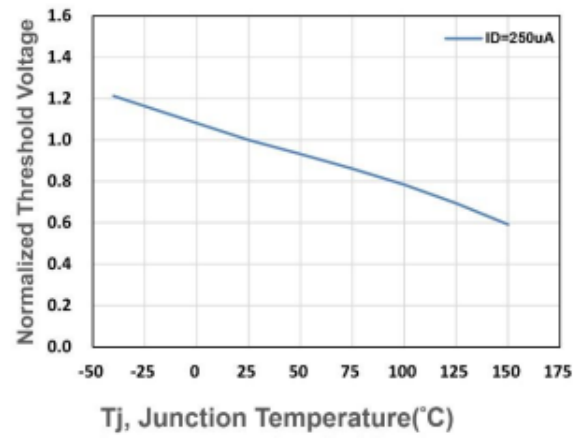


Figure 4. Gate Threshold Characteristics

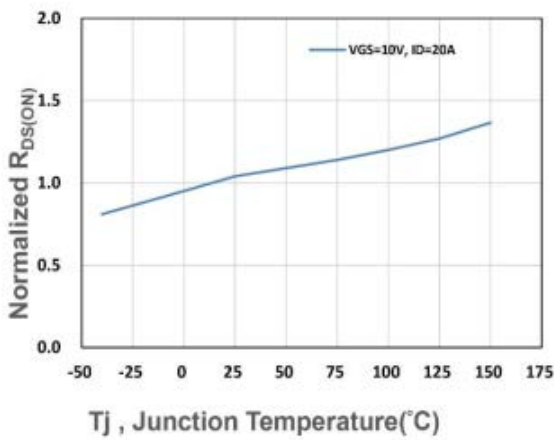


Figure 5. On-resistance vs. Drain-Source

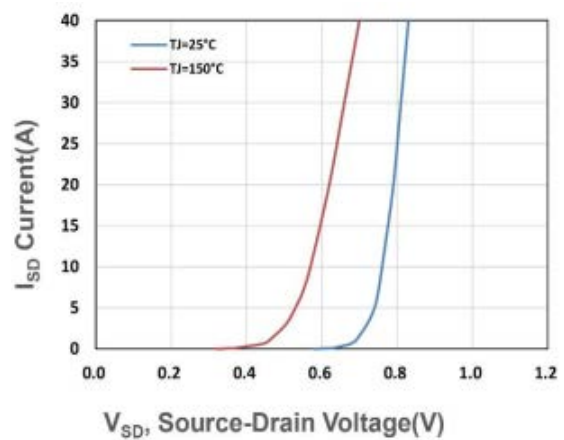


Figure 6. Drain-Source Diode Forward

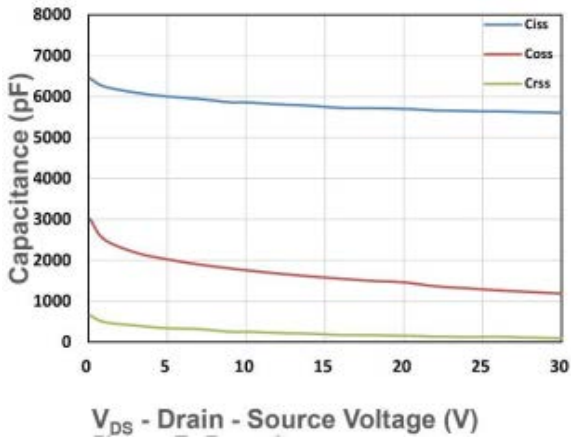


Figure 7. Capacitance Characteristics

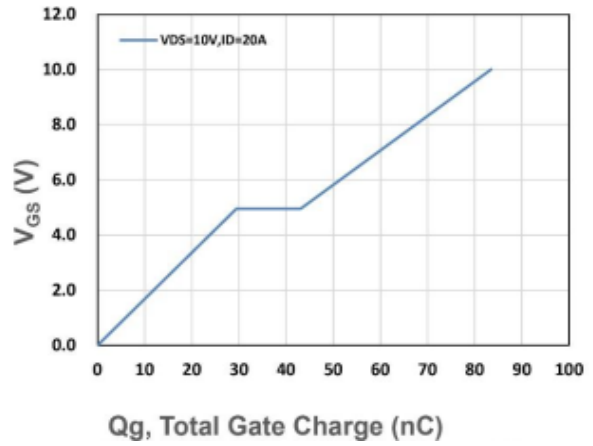


Figure 8. Gate Charge Characteristics

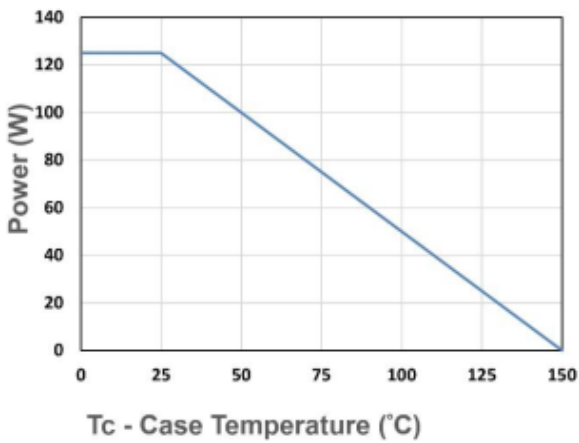


Figure 9. Power Dissipation

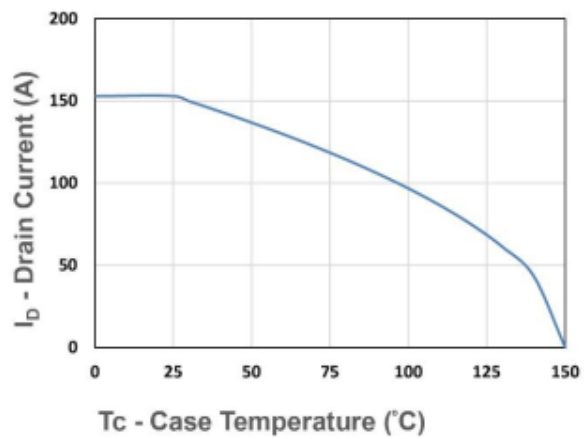


Figure 10. Drain Current

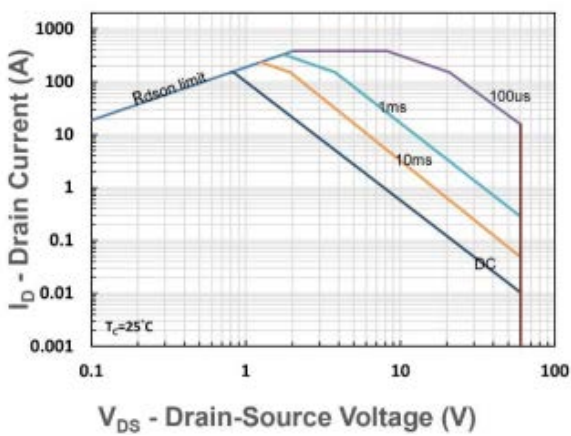


Figure 11. Safe Operating Area

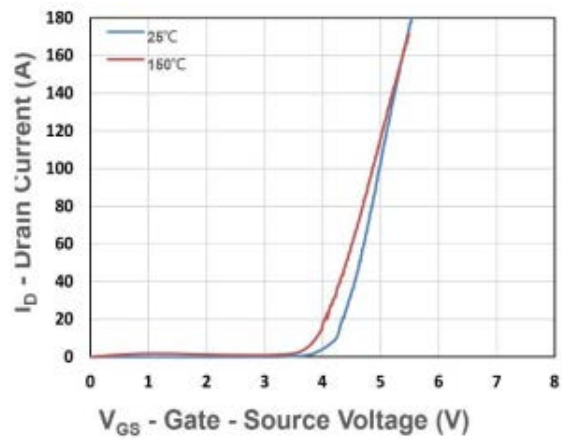


Figure 12. Transfer Characteristics

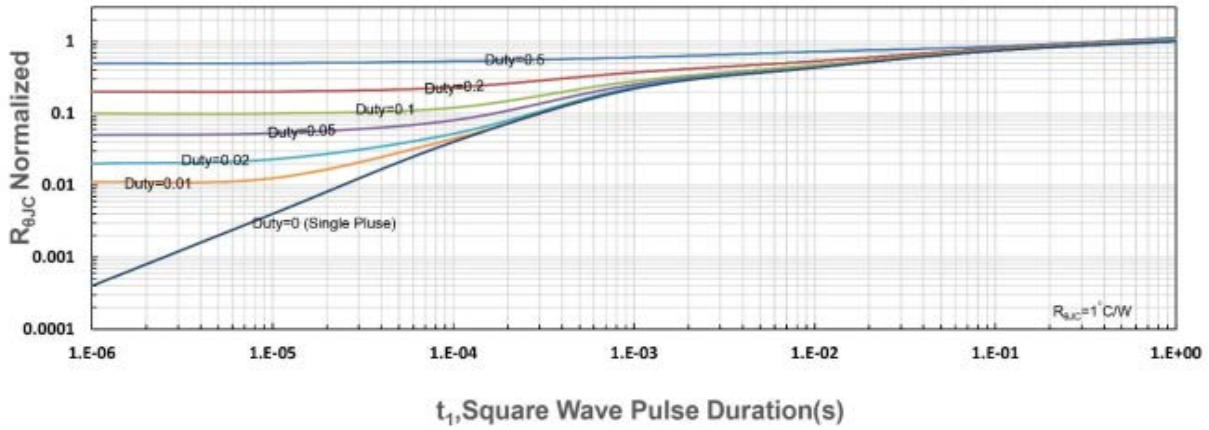
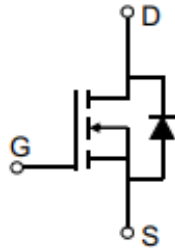
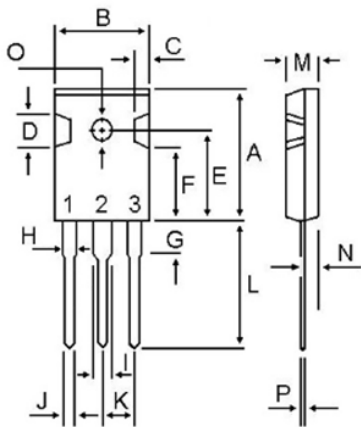


Figure 13. $R_{\theta JC}$ Transient Thermal Impedance

- Circuit diagram



- TO-247AB Package outlines : Dimensions in (mm)



DIM	MILLIMETERS	
	MIN	MAX
A	20.80	21.80
B	15.38	16.20
C	1.90	2.70
D	5.10	6.10
E	14.50	15.50
F	11.20	13.20
G	3.75	4.35
H	1.90	2.30
I	2.90	3.30
J	1.00	1.40
K	5.26	5.66
L	19.50	20.50
M	4.68	5.36
N	2.30	2.60
O	3.45	3.85
P	0.48	0.72

Notice

MOSPEC reserves the rights to make changes of the content herein the document anytime without notification. MOSPEC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies. Please refer to MOSPEC website for the last document.

MOSPEC disclaims any and all liability arising out of the application or use of any product including damages incidentally and consequentially incurred.

Application shown on the herein document are examples of standard use and operation. Customers are responsible for comprehending suitable use in particular applications. MOSPEC makes no representation or warranty that such application will be suitable for the specified use without further testing or modification.

The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by MOSPEC for any infringements of patents or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of MOSPEC or others.

These MOSPEC products are intended for usage in general electronic equipment. Please make sure to consult with MOSPEC before you use these MOSPEC products in equipment which require specialized quality and/or reliability, and in equipment which could have major impact to the welfare of human life (atomic energy control, aeronautics , traffic control, combustion control, safety devices etc.)